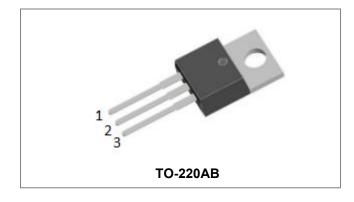


## MBR10100CTP

Technical Data Data Sheet N0619, Rev. A M



# MBR10100CTP SCHOTTKY RECTIFIER



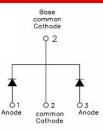
### Features

- 150 °C T<sub>J</sub> operation
- Center tap configuration
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced
- mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

### Applications

- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection

### **Circuit Diagram**



### Maximum Ratings:

Characteristics	Symbol	Condition	Max.	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	-	100	V
Average Rectified Forward Current	lf (AV)	50% duty cycle @Tc=105°C, rectangular wave form	5(Per Leg) 10(Per Device)	A
Peak One Cycle Non-Repetitive Surge Current(Per Leg)	IFSM	8.3ms, Half Sine pulse	120	А

### **Electrical Characteristics:**

Characteristics	Symbol	Condition	Тур.	Max.	Units
Forward Voltage Drop(Per Leg)*	V <sub>F1</sub>	@ 5A, Pulse, TJ = 25°C	0.80	0.85	V
	V <sub>F2</sub>	@ 5A, Pulse, TJ = 125°C	0.65	0.75	V
Reverse Current(Per Leg)*	I <sub>R1</sub>	$@V_R = rated V_R$ T <sub>J</sub> = 25°C	0.01	1.0	mA
	I <sub>R2</sub>	$@V_R = rated V_R$ T <sub>J</sub> = 125°C	0.2	15	mA
Junction Capacitance(Per Leg)	Ст	@V <sub>R</sub> = 5V, T <sub>C</sub> = 25°C, f <sub>SIG</sub> = 1MHz	130	300	pF
Series Inductance(Per Leg)	Ls	Measured lead to lead 5 mm from package body	8.0	-	nH
Voltage Rate of Change	dv/dt	-	-	10,000	V/μs

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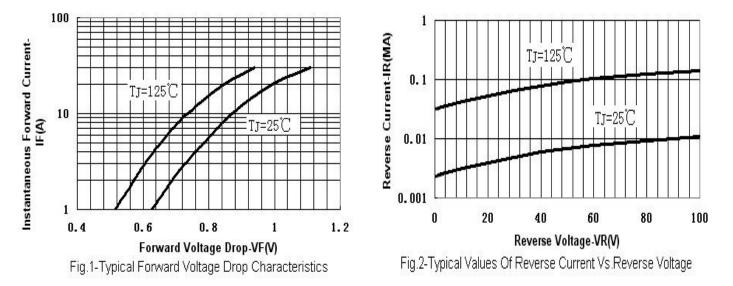
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Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +150	°C
Storage Temperature	T <sub>stg</sub>	-	-55 to +150	°C
Typical Thermal Resistance Junction to Case(Per Leg)	$R_{\theta JC}$	DC operation	2.0	°C/W
Approximate Weight	wt	-	2	g
Case Style	TO-220AB			





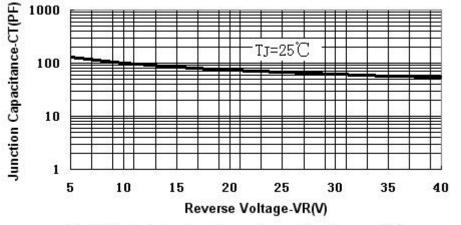


Fig.3-Typical Junction Capacitance Vs.Reverse Voltage

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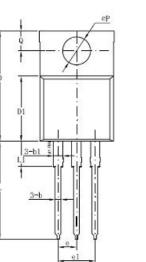
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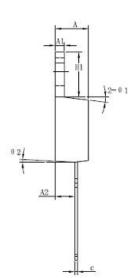
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### **Mechanical Dimensions TO-220AB**

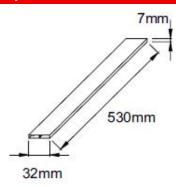




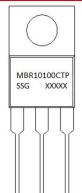


Symbol	Dimensions in millimeters			
	Min	Typical	Max	
Α	4.42	4.57	4.72	
A1	1.17	1.27	1.37	
A2	2.52	2.69	2.89	
b	0.71	0.81	0.96	
b1	1.17	1.27	1.37	
С	0.31	0.38	0.61	
D	14.94	15.24	15.54	
D1	8.85	9.00	9.15	
E	10.01	10.16	10.31	
е		2.54		
e1	4.98	5.06	5.18	
H1	6.04	6.24	6.44	
L	12.7	13.56	13.80	
L1	3.56	3.5	3.96	
ΦΡ	3.74	3.84	4.04	
Q	2.54	2.74	2.94	
Θ1		7°		
Θ2		3°		
Θ3		<b>4</b> °		

### Tube Specification



### **Marking Diagram**



#### Where XXXXX is YYWWL

- MBR = Device Type 10 = Forward Curre
  - = Forward Current (10A) = Reverse Voltage(100V)
  - = Reverse Voltag = Configuration
  - = SSG

100

CTP

SSG

YΥ

L

ww

= Year

= Week

= Lot Number

Cautions: Molding resin Epoxy resin UL:94V-0

### **Ordering Information**

Device	Package	Shipping	
MBR10100CTP	TO-220AB (Pb-Free)	50 pcs/ tube	

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging Specification.

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## MBR10100CTP



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